

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Complementary Plastic Silicon Power Transistors

The MJE170/180 series is designed for low power audio amplifier and low current, high speed switching applications.

Features

- High DC Current Gain
- High Current-Gain Bandwidth Product
- Annular Construction for Low Leakages
- Epoxy Meets UL 94 V-0 @ 0.125 in
- These Devices are Pb-Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Base Voltage MJE170G, MJE180G MJE171G, MJE181G MJE172G, MJE182G	V _{CB}	60 80 100	Vdc
Collector-Emitter Voltage MJE170G, MJE180G MJE171G, MJE181G MJE172G, MJE182G	V _{CEO}	40 60 80	Vdc
Emitter-Base Voltage	V _{EB}	7.0	Vdc
Collector Current – Continuous	I _C	3.0	Adc
Collector Current – Peak	I _{CM}	6.0	Adc
Base Current	I _B	1.0	Adc
Total Power Dissipation @ T _C = 25°C Derate above 25°C	P _D	12.5 0.012	W W/°C
Total Power Dissipation @ T _A = 25°C Derate above 25°C	P _D	1.5 0.1	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +150	°C
ESD – Human Body Model	HBM	3B	V
ESD – Machine Model	MM	С	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

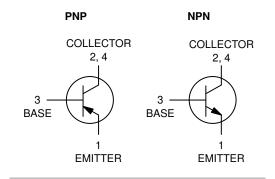
1



ON Semiconductor®

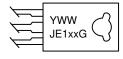
http://onsemi.com

3 AMPERES **POWER TRANSISTORS COMPLEMENTARY SILICON** 40 - 60 - 80 VOLTS **12.5 WATTS**





MARKING DIAGRAM



= Year

ww = Work Week

= Specific Device Code JE1xx

x = 70, 71, 72, 80, 81, or 82

G = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	10	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	83.4	°C/W

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•	•
Collector–Emitter Sustaining Voltage (I _C = 10 mAdc, I _B = 0) MJE170G, MJE180G MJE171G, MJE181G MJE172G, MJE182G	V _{CEO(sus)}	40 60 80	- - -	Vdc
Collector Cutoff Current (V _{CB} = 60 Vdc, I _E = 0) MJE170G, MJE180G (V _{CB} = 80 Vdc, I _E = 0) MJE171G, MJE181G	Ісво	-	0.1 0.1	μAdc
		-	0.1	mAdc
MJE172G, MJE182G			0.1	
Emitter Cutoff Current $(V_{BE} = 7.0 \text{ Vdc}, I_C = 0)$	I _{EBO}	-	0.1	μAdc
ON CHARACTERISTICS				
DC Current Gain $ \begin{array}{l} (I_C=100 \text{ mAdc, V}_{CE}=1.0 \text{ Vdc)} \\ (I_C=500 \text{ mAdc, V}_{CE}=1.0 \text{ Vdc)} \\ (I_C=1.5 \text{ Adc, V}_{CE}=1.0 \text{ Vdc)} \end{array} $	h _{FE}	50 30 12	250 - -	-
Collector–Emitter Saturation Voltage ($I_C = 500$ mAdc, $I_B = 50$ mAdc) ($I_C = 1.5$ Adc, $I_B = 150$ mAdc) ($I_C = 3.0$ Adc, $I_B = 600$ mAdc)	V _{CE(sat)}	- - -	0.3 0.9 1.7	Vdc
Base-Emitter Saturation Voltage ($I_C = 1.5 \text{ Adc}, I_B = 150 \text{ mAdc}$) ($I_C = 3.0 \text{ Adc}, I_B = 600 \text{ mAdc}$)	V _{BE(sat)}	<u>-</u> -	1.5 2.0	Vdc
Base-Emitter On Voltage (I _C = 500 mAdc, V _{CE} = 1.0 Vdc)	V _{BE(on)}	_	1.2	Vdc
DYNAMIC CHARACTERISTICS	<u>. </u>			
Current–Gain – Bandwidth Product (Note 1) (I _C = 100 mAdc, V _{CE} = 10 Vdc, f _{test} = 10 MHz)	f _T	50	-	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 0.1 MHz) MJE171G/MJE172G MJE181G/MJE182G	C _{ob}	- -	60 40	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. $f_T = |h_{fe}| \cdot f_{test}$.

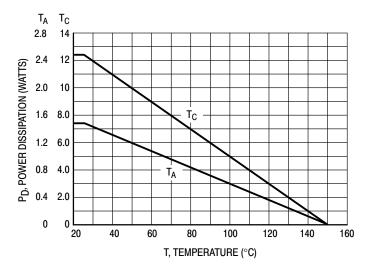
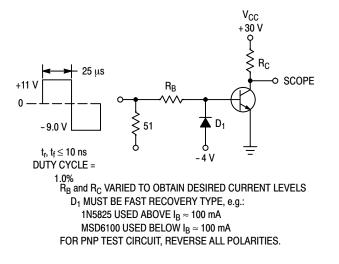


Figure 1. Power Derating

1K



V_{CE} = 30 V 500 $I_C/I_B = 10$ 300 200 $V_{BE(off)} = 4.0 V$ $T_{J} = 25^{\circ}C$ 100 t, TIME (ns) 50 30 20 10 NPN MJE181/182 PNP MJE171/172 0.02 0.03 0.05 0.1 0.2 0.3 0.5 I_C, COLLECTOR CURRENT (AMPS)

Figure 2. Switching Time Test Circuit

Figure 3. Turn-On Time

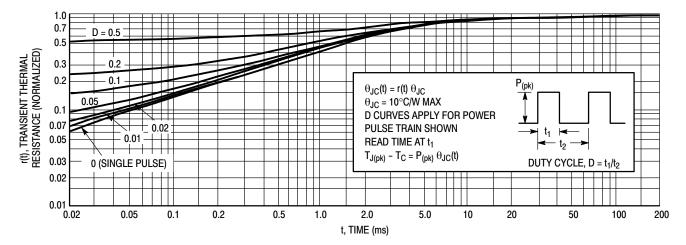


Figure 4. Thermal Response

ACTIVE-REGION SAFE OPERATING AREA

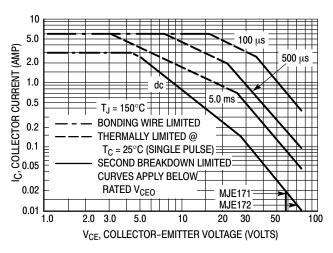


Figure 5. MJE171, MJE172

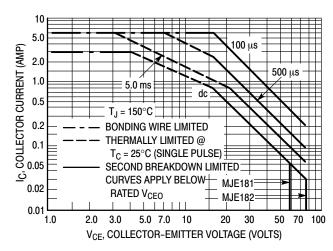


Figure 6. MJE181, MJE182

There are two limitations on the power handling ability of a transistor – average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figures 5 and 6 is based on $T_{J(pk)} = 150^{\circ}C$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ}C$. $T_{J(pk)}$ may be calculated from the data in Figure 4. At high case temperature, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

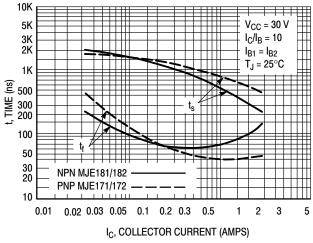


Figure 7. Turn-Off Time

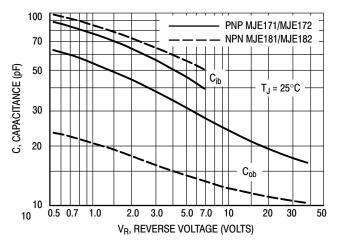
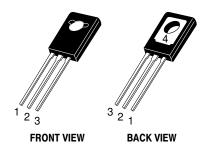


Figure 8. Capacitance

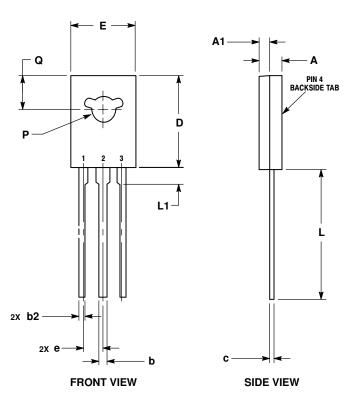
ORDERING INFORMATION

Device	Package	Shipping
MJE170G	TO-225 (Pb-Free)	500 Units / Box
MJE171G	TO-225 (Pb-Free)	500 Units / Box
MJE172G	TO-225 (Pb-Free)	500 Units / Box
MJE180G	TO-225 (Pb-Free)	500 Units / Box
MJE181G	TO-225 (Pb-Free)	500 Units / Box
MJE182G	TO-225 (Pb-Free)	500 Units / Box

PACKAGE DIMENSIONS



TO-225 CASE 77-09 ISSUE AC



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. NUMBER AND SHAPE OF LUGS OPTIONAL.

	MILLIMETERS	
DIM	MIN	MAX
Α	2.40	3.00
A1	1.00	1.50
b	0.60	0.90
b2	0.51	0.88
С	0.39	0.63
D	10.60	11.10
E	7.40	7.80
е	2.04	2.54
L	14.50	16.63
L1	1.27	2.54
P	2.90	3.30
Q	3.80	4.20

PIN 1 FMITTER COLLECTOR 2., 4.

ON Semiconductor and 📖 are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, ON semiconductor and war registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC wors the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent—Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implications the product could receive a situation where surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada **Fax**: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative